



# The High-Voltage Monolithic Active Pixel Sensor for the Mu3e Experiment

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On Behalf of the Mu3e Collaboration

International Conference on  
Technology and Instrumentation in Particle Physics  
2-6 June, 2014



# Outline

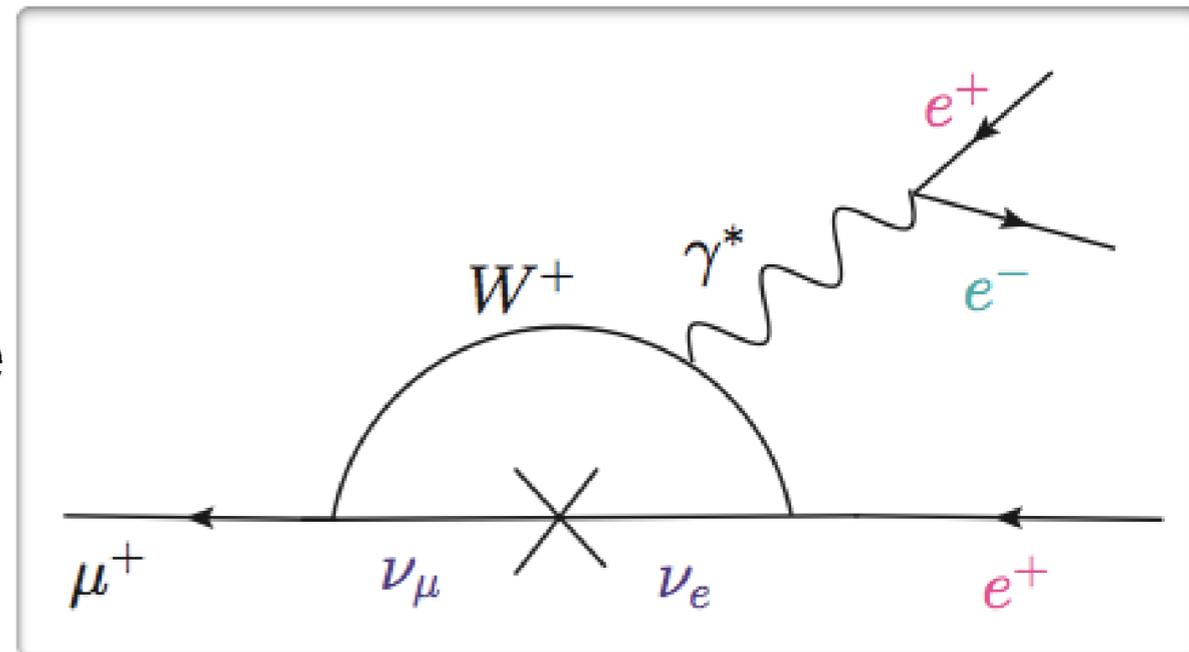
- The decay  $\mu \rightarrow eee$
- The Mu3e Experiment
  - The Mu3e Pixel Detector based on HV-MAPS
  - Results from Test Beam at DESY 2013/2014



# Motivation

- The Mu3e experiment searches for :
  - Lepton flavor violation in the decay of  $\mu^+ \rightarrow e^+e^+e^-$  with a sensitivity of  $\text{BR} < 10^{-16}$
  - Four orders of magnitude improvement over the most stringent limit to date

- In the SM, the decay is suppressed to unobservable levels ( $\text{BR} < 10^{-54}$ )

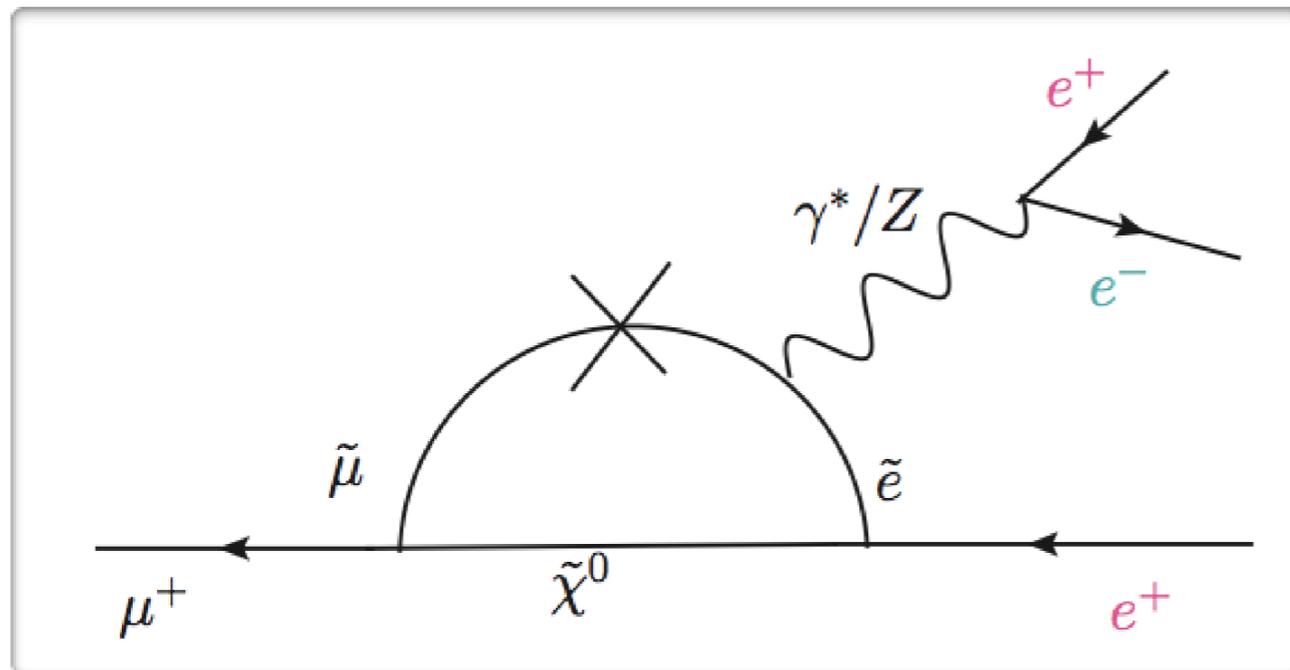


- Any observed signal event is a clear signature of new phenomena beyond the SM

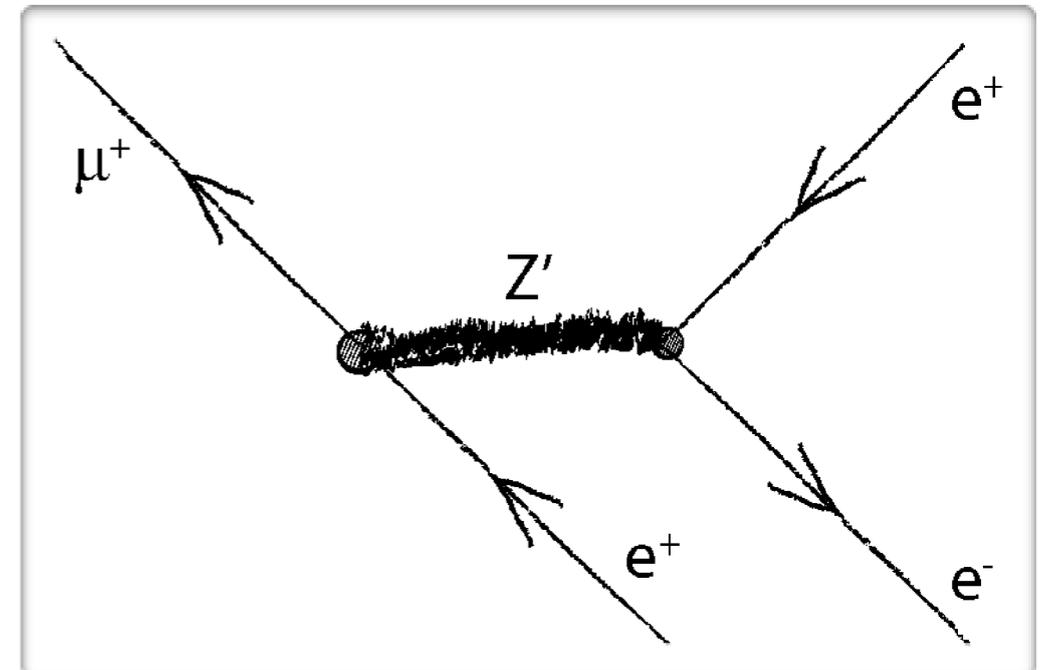


# Motivation

- The experiment allows to test models involving new particles
- Supersymmetry
- Extended Higgs models
- Heavy vector bosons



Supersymmetry



LFV at tree level



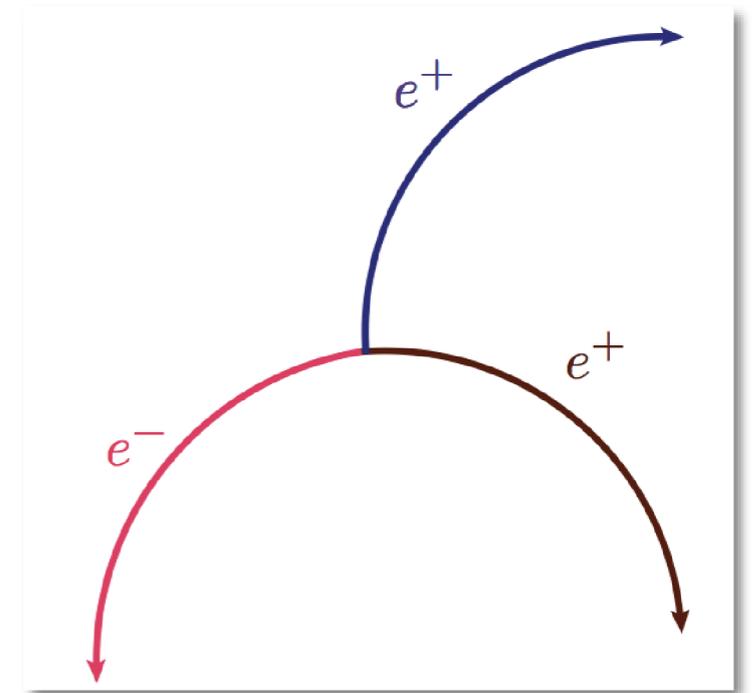
# Signal and Backgrounds

- Decay signature: Muon decays at rest

- Two positrons and an electron

- Opposite curvature in magnetic field

- Coincident in time, originating from same vertex



- Momentum conservation:  $|\vec{p}_{tot}| = |\Sigma\vec{p}_i| = 0$

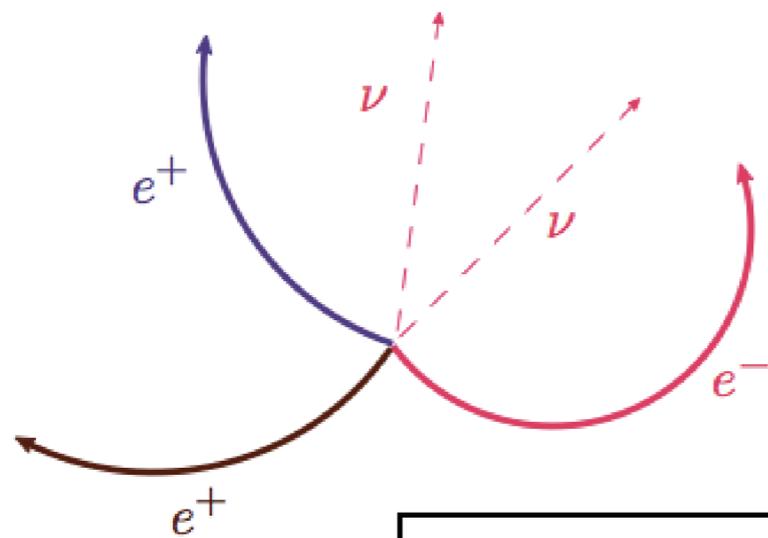
- Energy conservation:  $E_{tot} = \Sigma E_i = m_{\mu}c^2$

- Individual energies are below 53 MeV

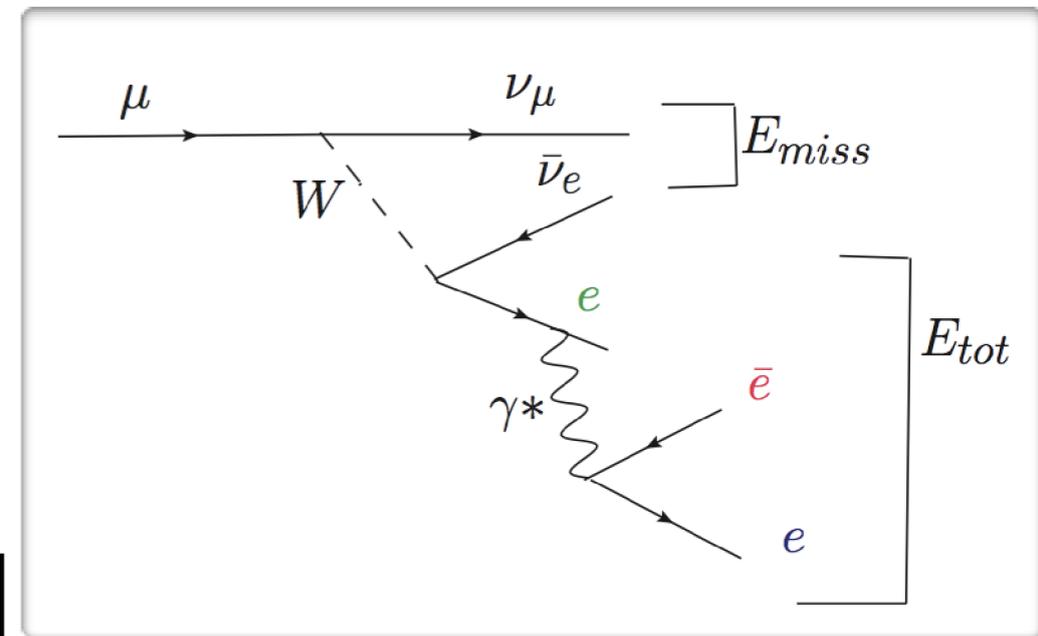


# Signal and Backgrounds

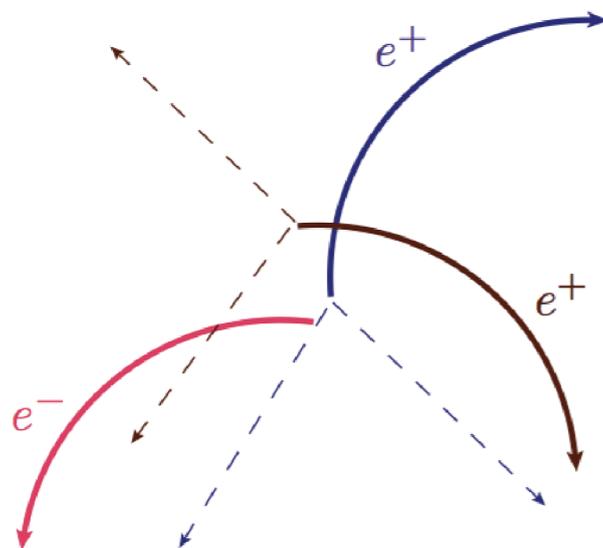
- Internal Conversion ( Radiative muon decay)



Good momentum and total energy resolution required



- Combinatorials

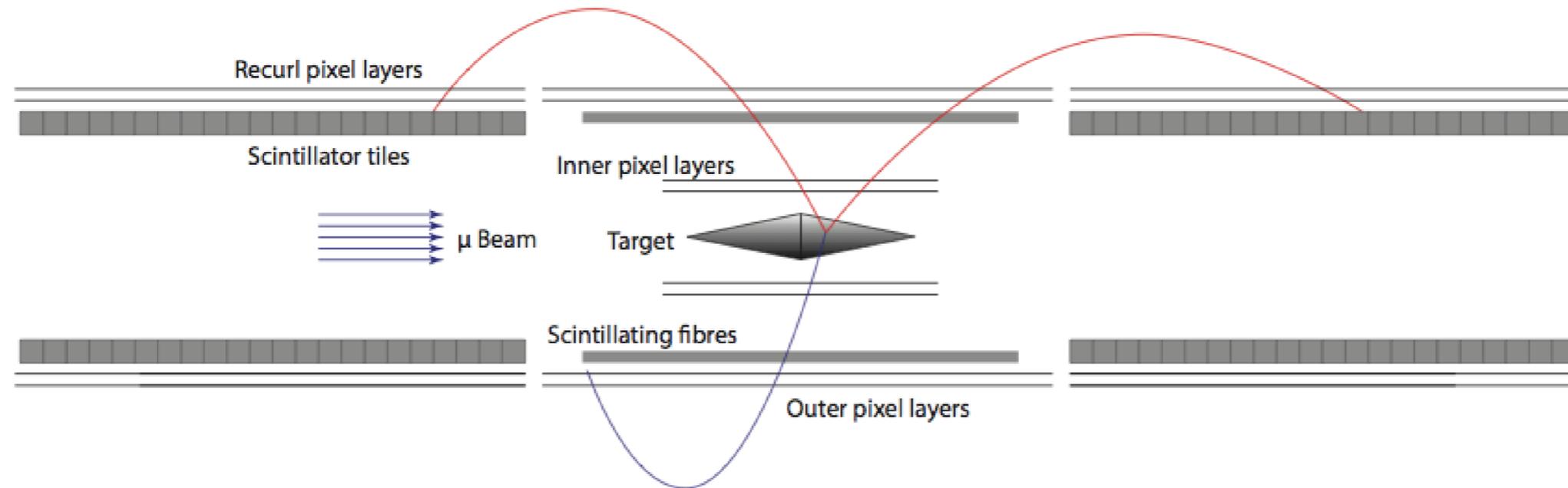


Precise timing, good momentum and vertex resolution required

$$\sigma_p < 0.3 \text{ MeV}, \quad \sigma_t < 100 \text{ ps}$$



# Mu3e Experiment

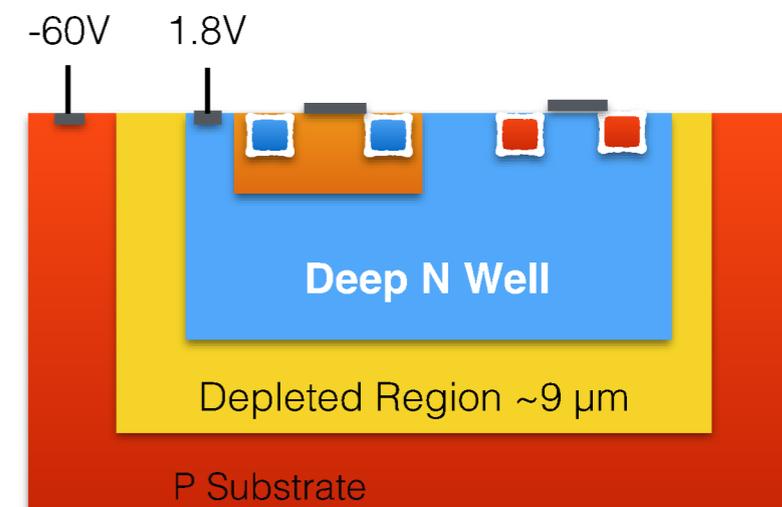


- To achieve sensitivity goal:
  - $10^9$  muon decays/s
  - excellent vertex resolution
  - excellent time resolution
- Low  $p_T < 53$  MeV/c decay product, track resolution dominated by multiple scattering.
- High granularity Si- based tracking detector made of HV-MAPS



# HV-MAPS

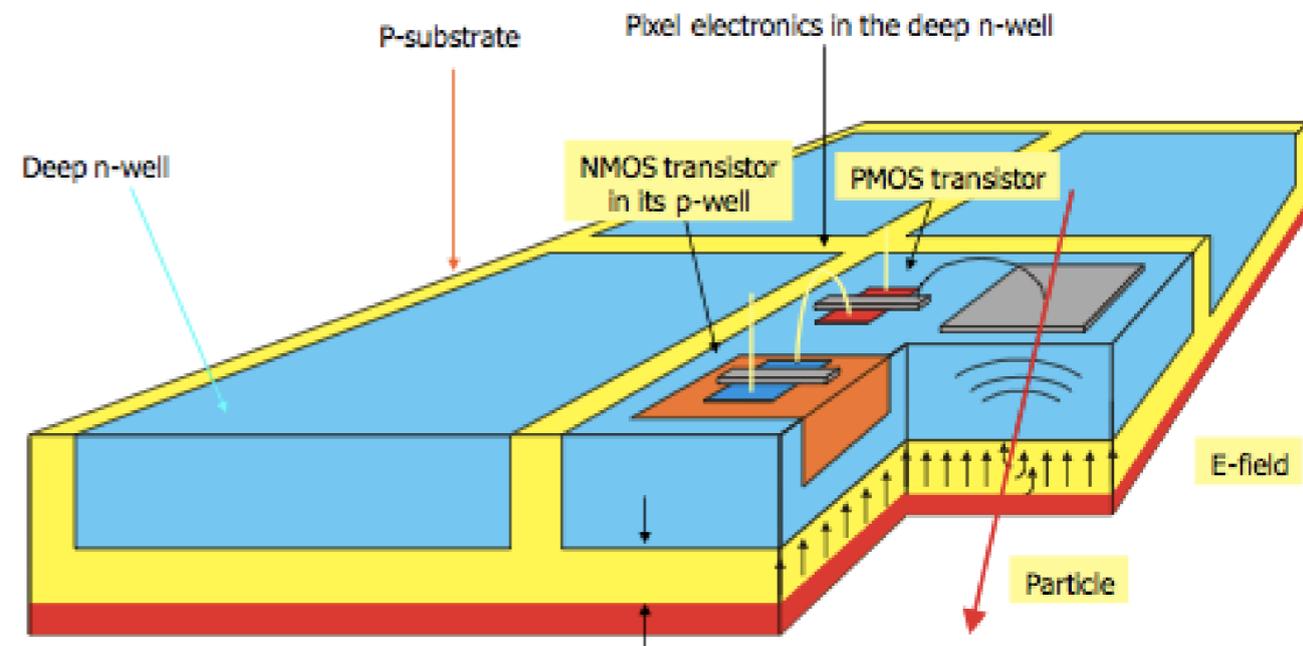
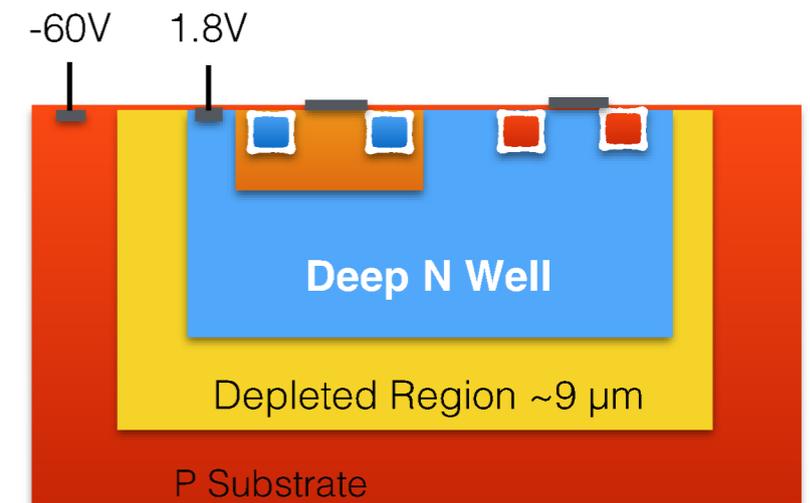
- HV-MAPS as a particle detector
- Based on 180 nm HV-CMOS technology
- Fast charge collection ( $< 100$  ps) via drift, results in high radiation tolerance
- Thinning to  $< 50$   $\mu\text{m}$
- Power consumption  $\sim 7.5$   $\mu\text{W}/\text{pixel}$
- Relatively cheap due to use of commercial process





# HV-MAPS

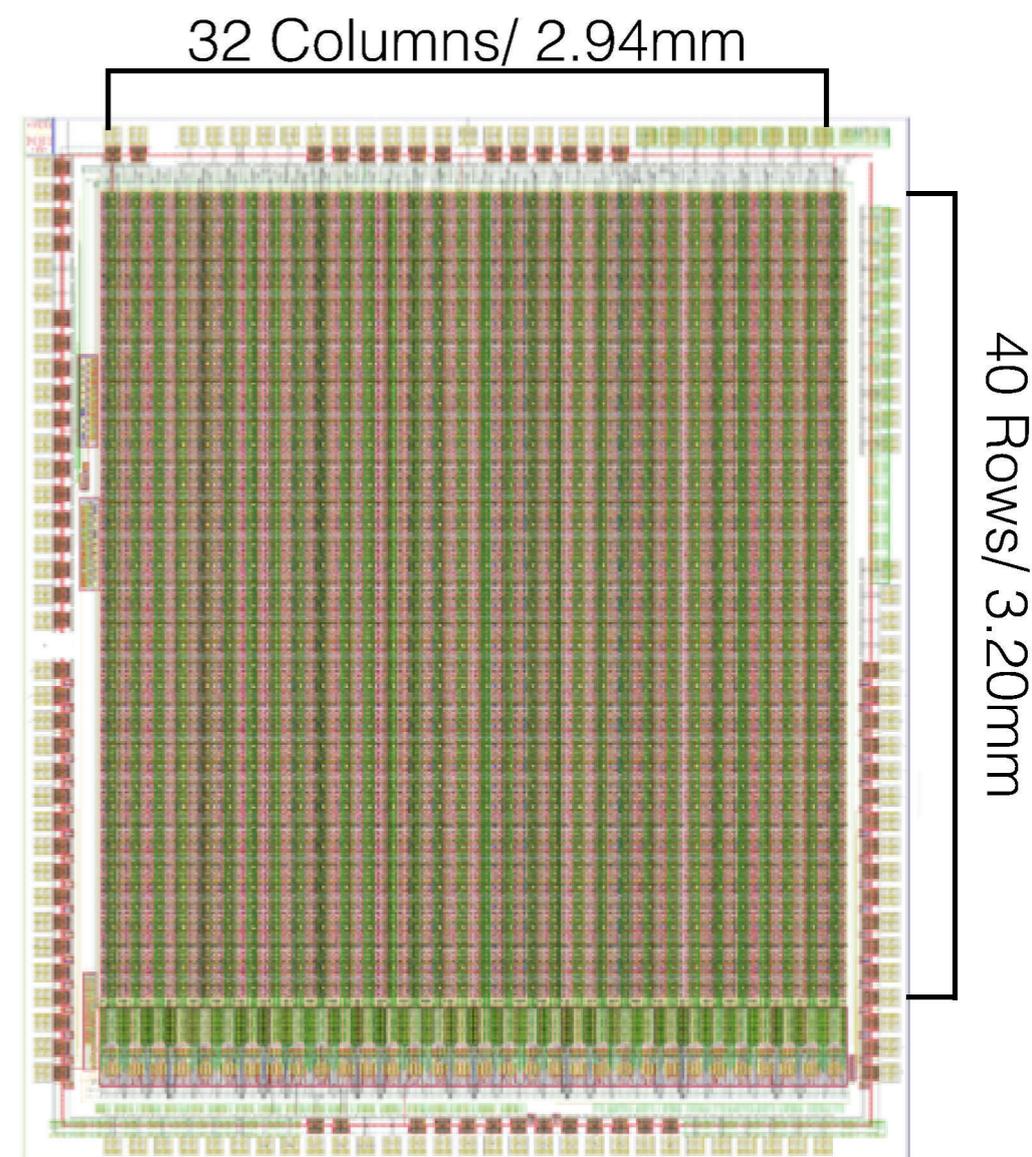
- Low doped deep N- well as signal collecting region
- Depleted p-n junction as a sensor  $\sim 9 \mu\text{m}$
- The charge collected by drift  $\sim 625 e$  in depleted region using  $\text{Sr}^{90}$  as a source
- Entire pixel electronics CMOS transistors inside the deep N-well
- Integrated readout electronics
- N- well are in matrix, **depleted zones overlapped  $\sim 100\%$  fill factor**





# MUPIX4

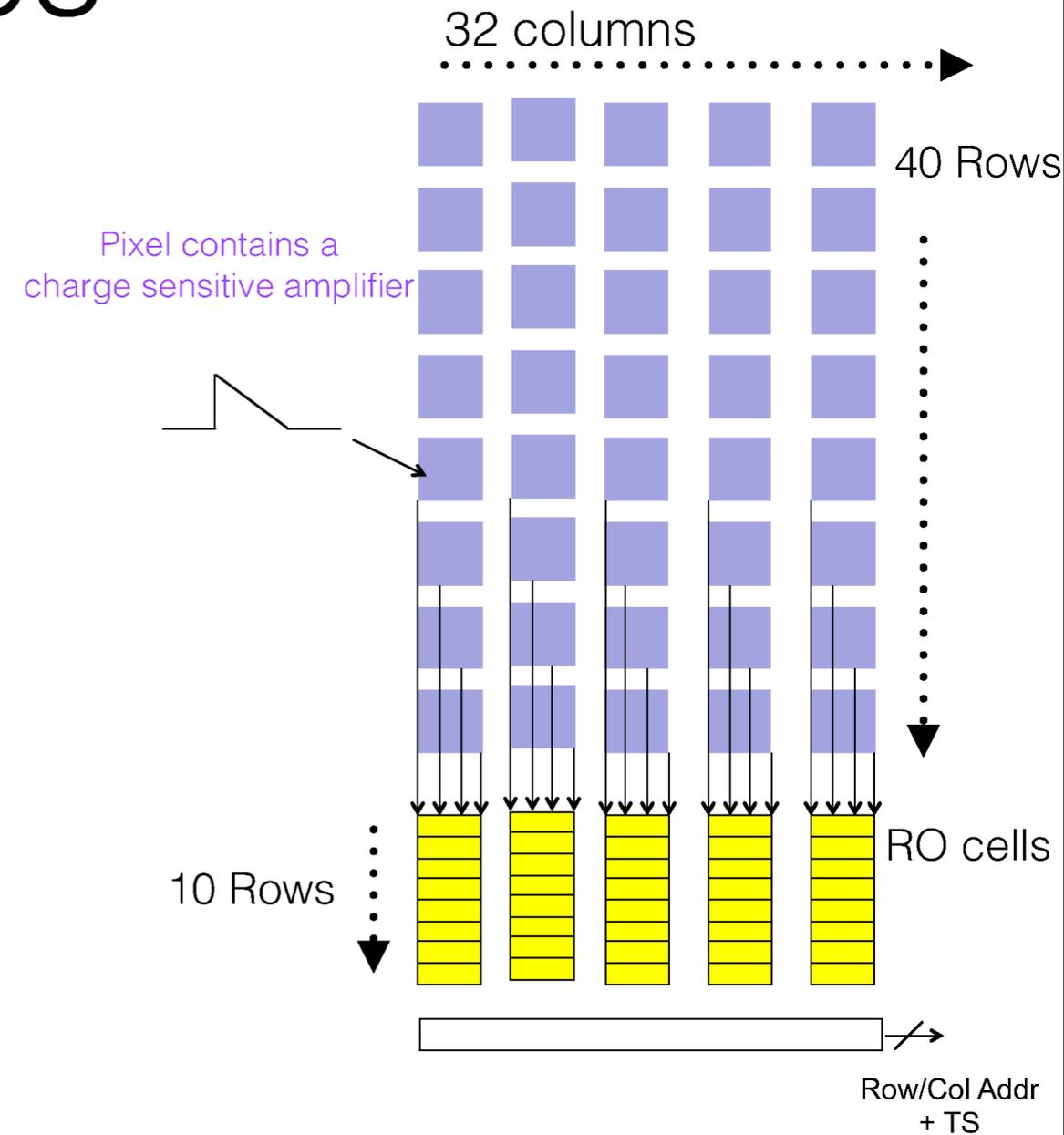
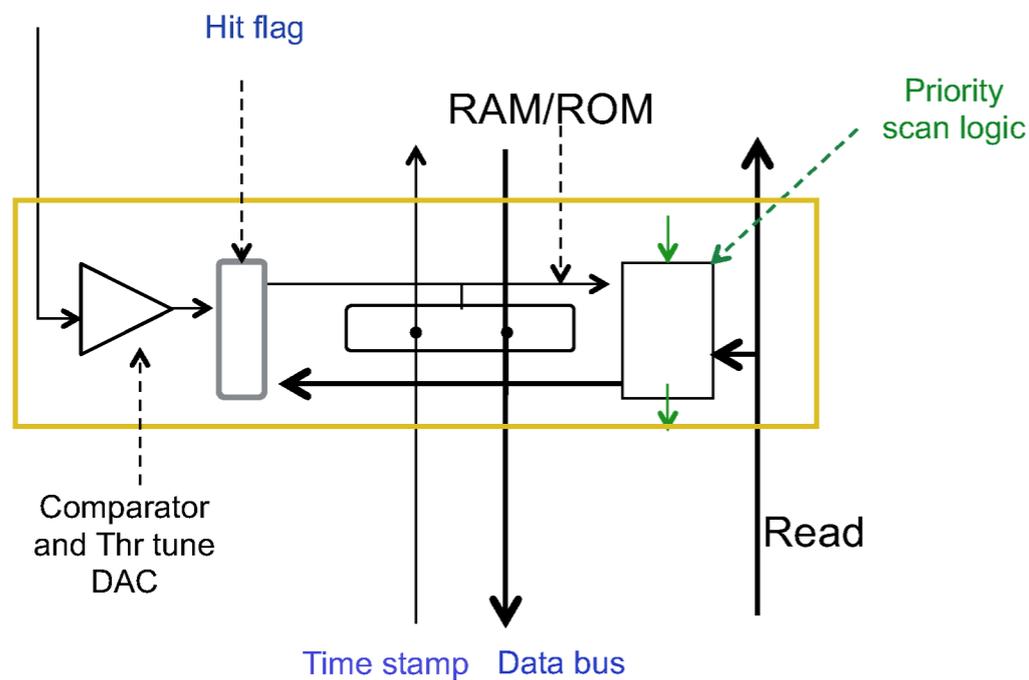
- Features : AMS 180nm process
- Pixel Matrix: 40x32 pixels, 80x92  $\mu\text{m}^2$  (pixel size) Active area : 9.4  $\text{mm}^2$
- Moderate substrate resistivity  $\sim 10 \Omega \text{ cm}$
- Designed by Ivan Peric (U. Heidelberg Institute for Computer Science (ZITI))
- Analog part: Small pixel capacitance  
Temperature tolerance
- Digital part: Zero suppression  
Mostly Ready  
Feature: pixel address problem in half column  
Fixed in MUIPIX6 using inverters



# HV-MAPS: Integrated readout electronics



**Concept:** Each pixel has its own read out (RO) cell placed on the chip periphery



Readout cell function:

Time stamp

Hit data

Priority logic

Binary Suppressed read out

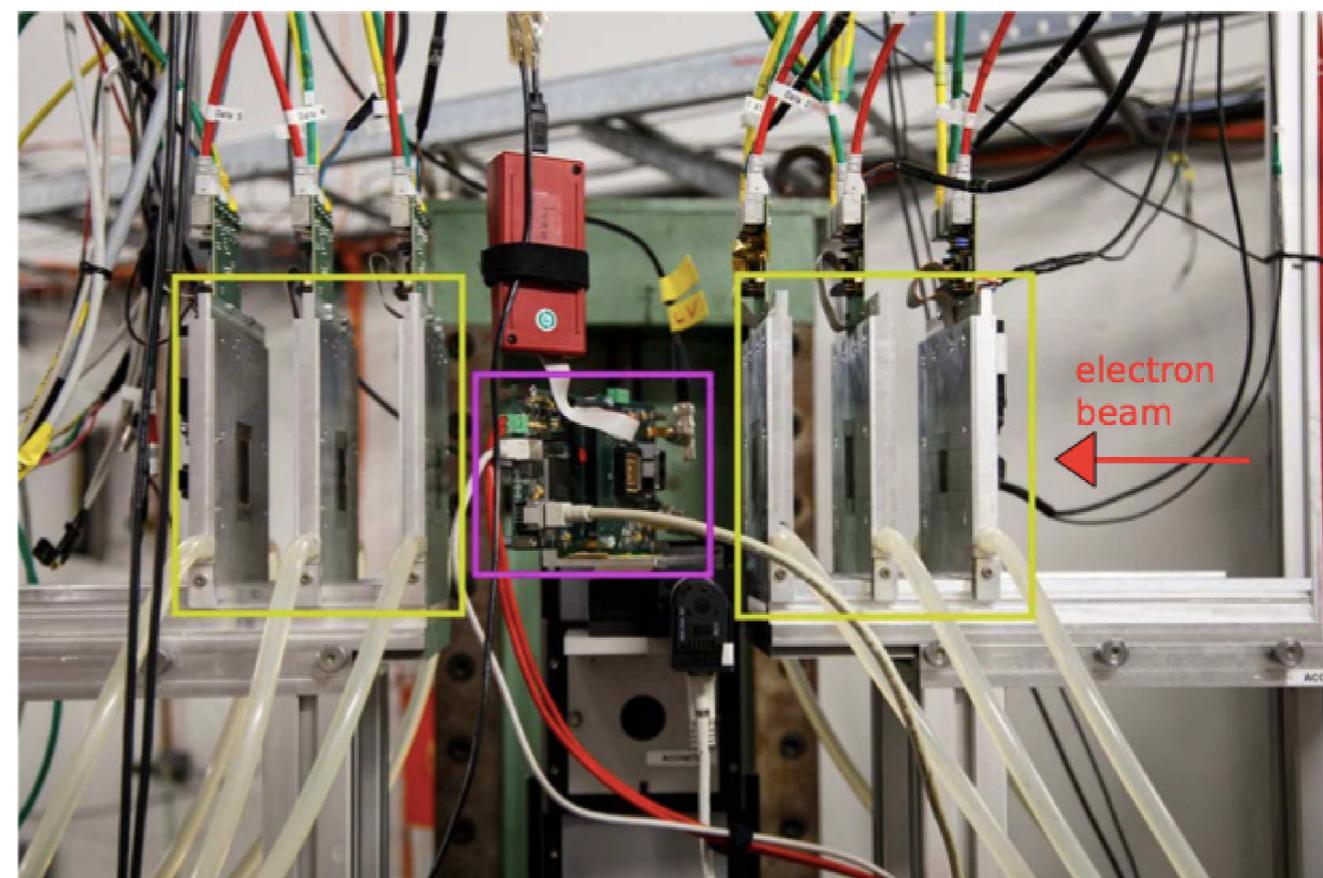
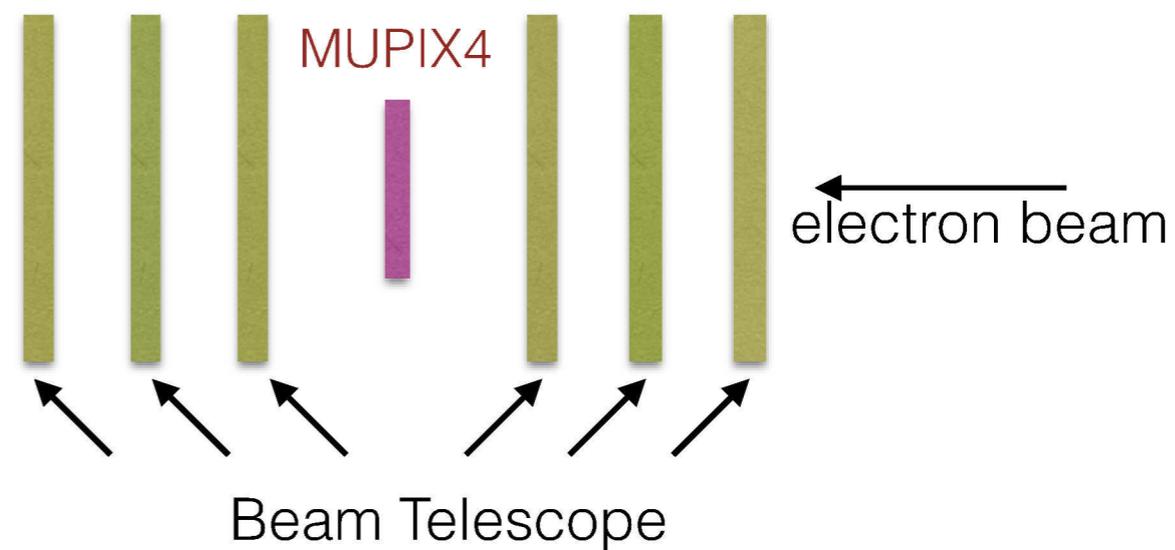
RO cell size is  $7\mu\text{m} \times 40\mu\text{m}$  in 180nm AMS process (with comparator and threshold tune DAC)

# Test Beam set up at DESY



- DESY Test Beam set up

- Beam-line T22
- 1 GeV to 6 GeV electrons
- EUDET Telescope
- MUIPIX4 prototype



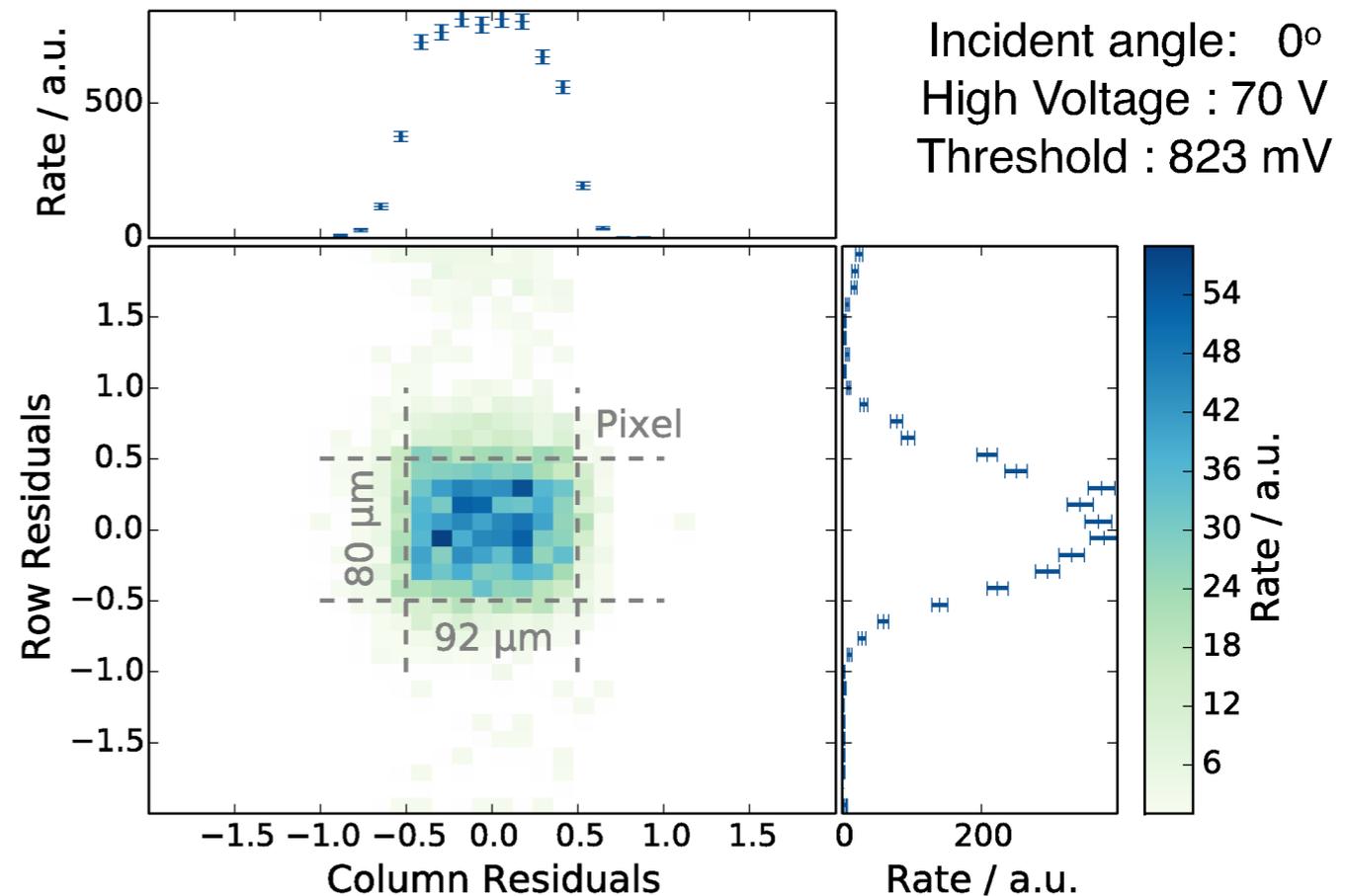
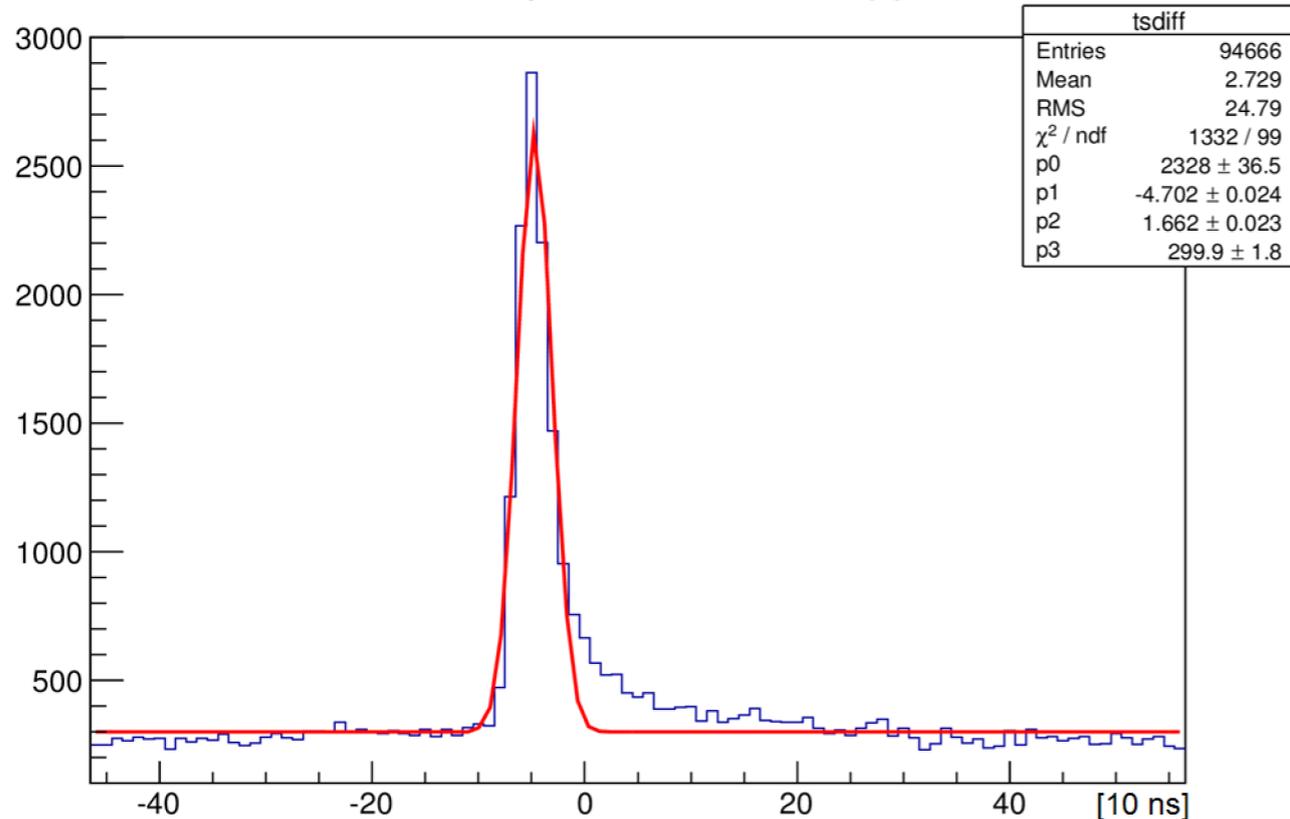


# Test Beam Results

# Time and Single Hit Resolution



Timestamp difference to trigger



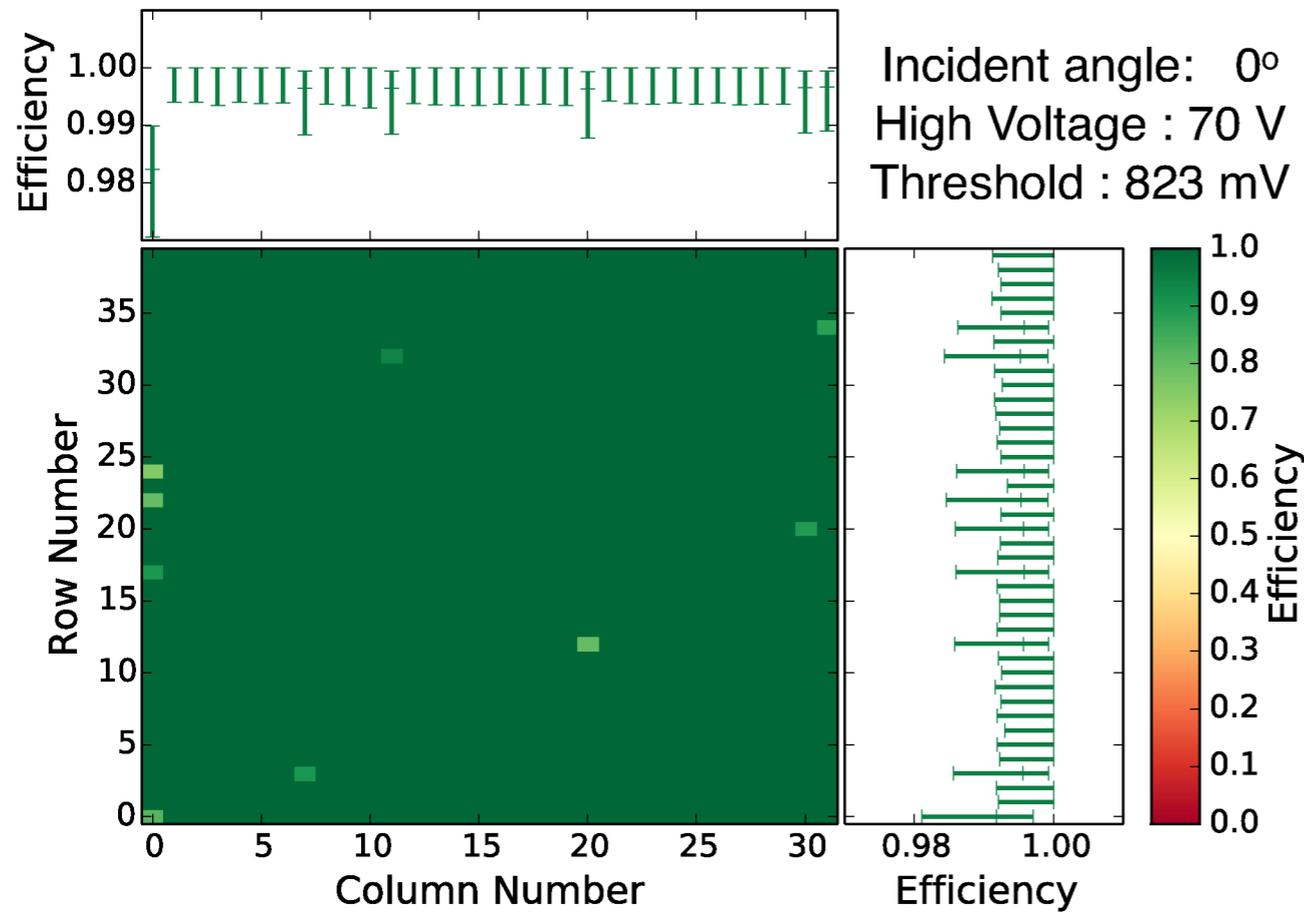
Result: Time Resolution : 17 ns  
(Sensor and DAQ)  
External Gray counter at 100 MHz

Result: Resolution given by pixel size  
Measured track residuals:  
RMS x = 28  $\mu\text{m}$ , RMS y = 29  $\mu\text{m}$



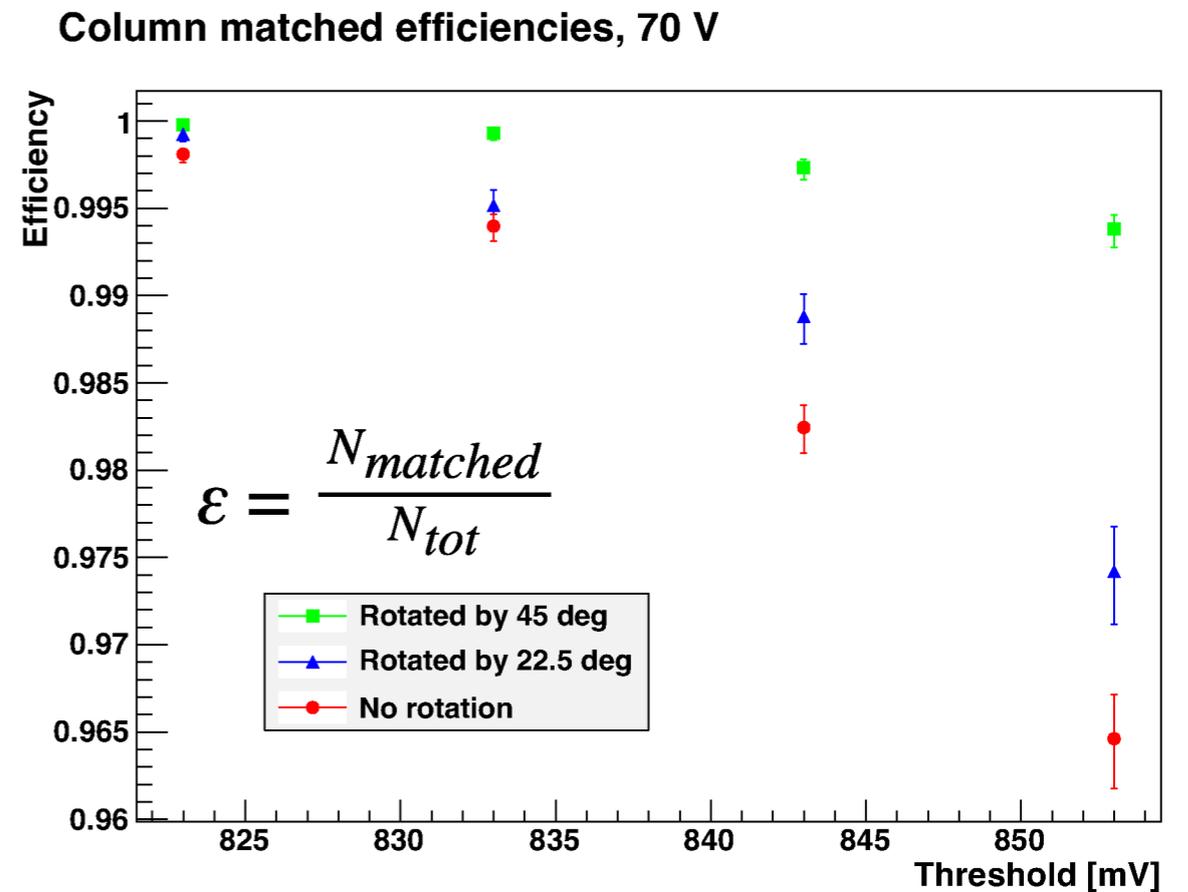
# Pixel Efficiency

Pixel Efficiency



Result: First working prototype  
Efficiency > 99% for untuned DAC

Pixel Efficiency



Result: Rotated chip with 45 degree  
angle, higher efficiency



# Conclusion

- Mu3e experiment aims for  $\mu^+ \rightarrow e^+ e^+ e^-$  with sensitivity of  $\text{BR} < 10^{-16}$
- HV-MAPS has been implemented for fast charge collection efficiency, radiation hardness and minimum material
- Looking forward to integrate full digital electronics in the Mu3e pixel prototype by end of this year
- The MUIPIX4 has already the required analog performance
- Currently, the performance of MUIPIX6 is being tested at PSI



Backup slides

# Mechanical prototype and sandwich Design



HV-MAP

Thinned to 50  $\mu\text{m}$

sensor size 1 x 2  $\text{cm}^2$  or 2x2  $\text{cm}^2$

Kapton™ flex print

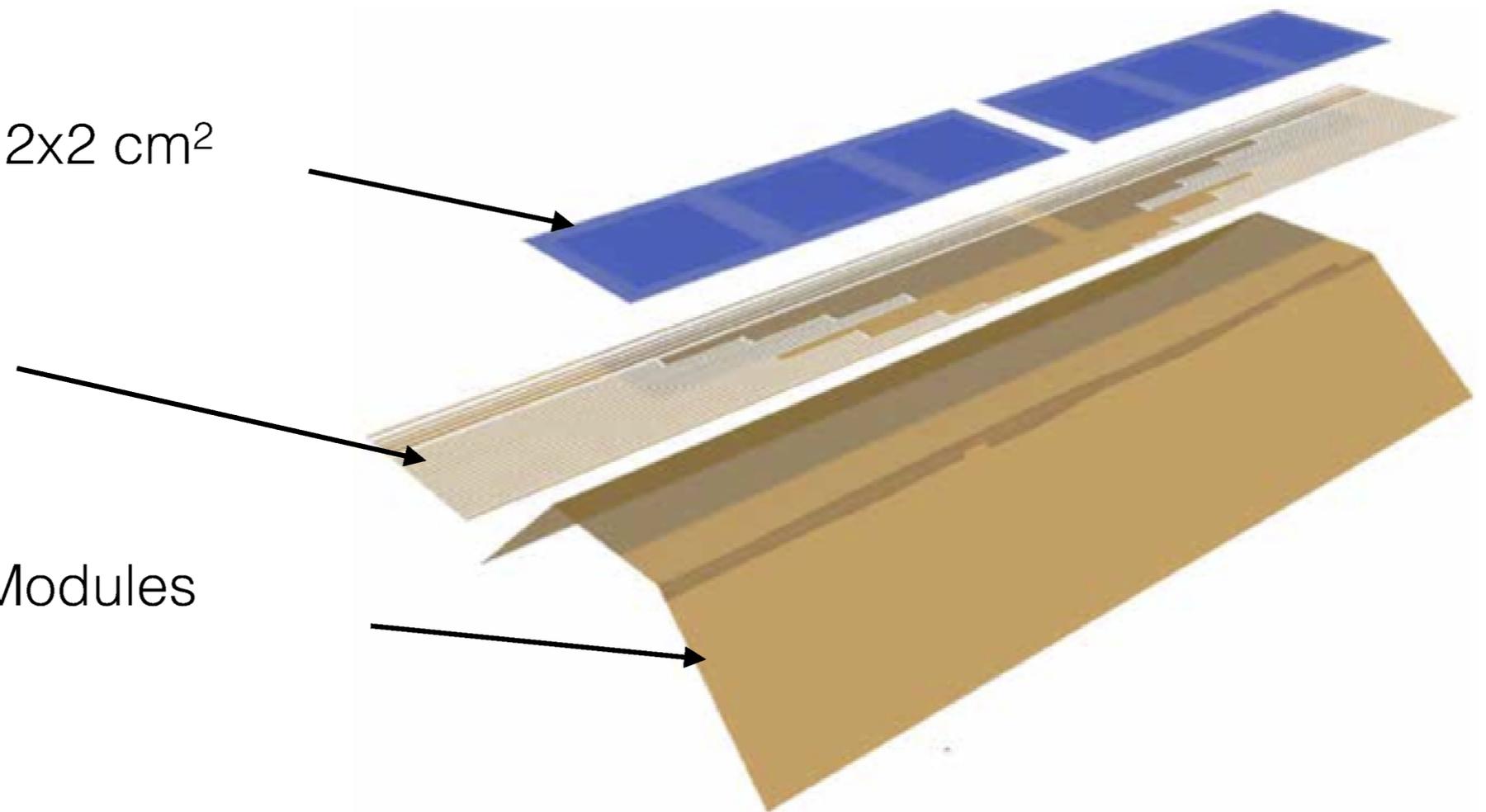
25  $\mu\text{m}$  Kapton™

12.5  $\mu\text{m}$  Al traces

Kapton™ Frame Modules

25  $\mu\text{m}$  foil

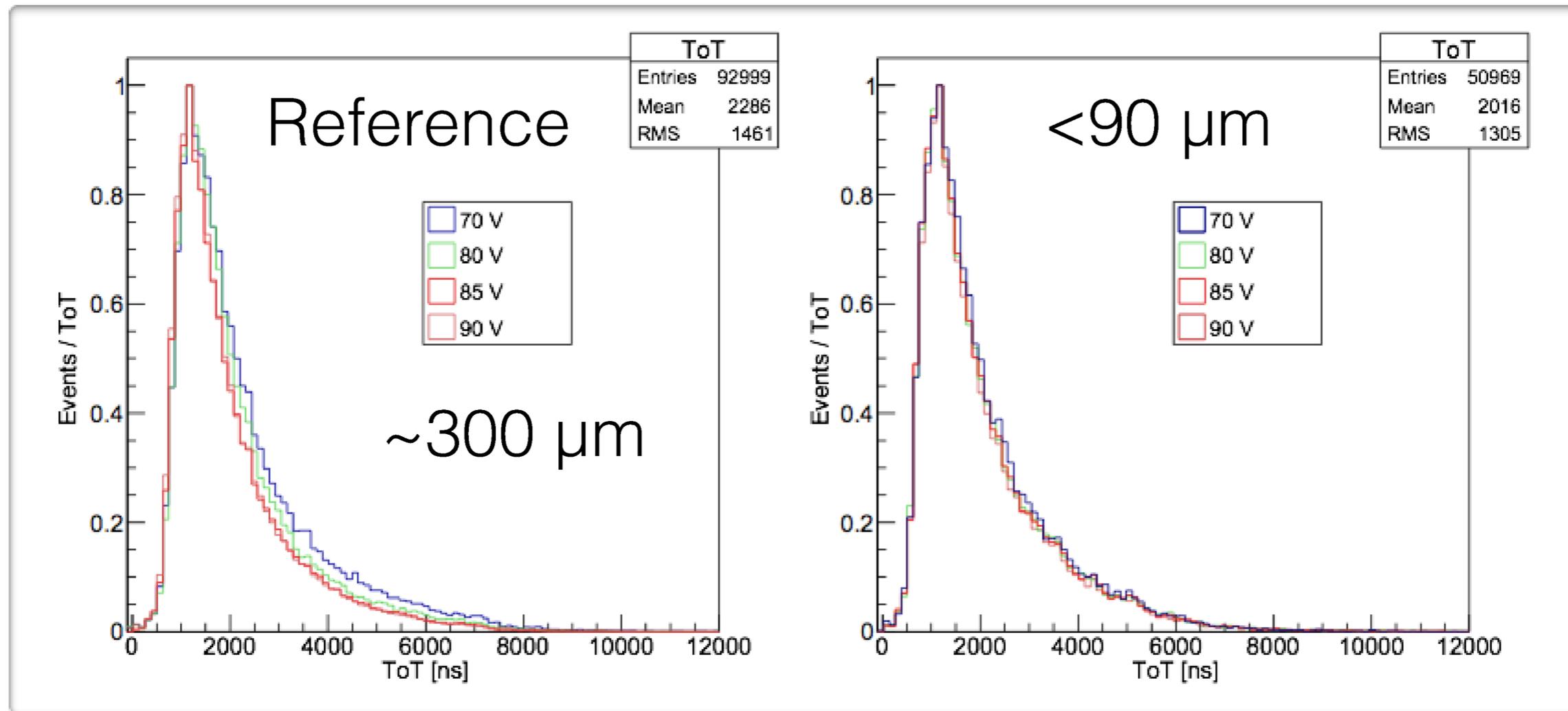
self support



$<0.1\%$   $X_0$  per layer



# Thinned sensor



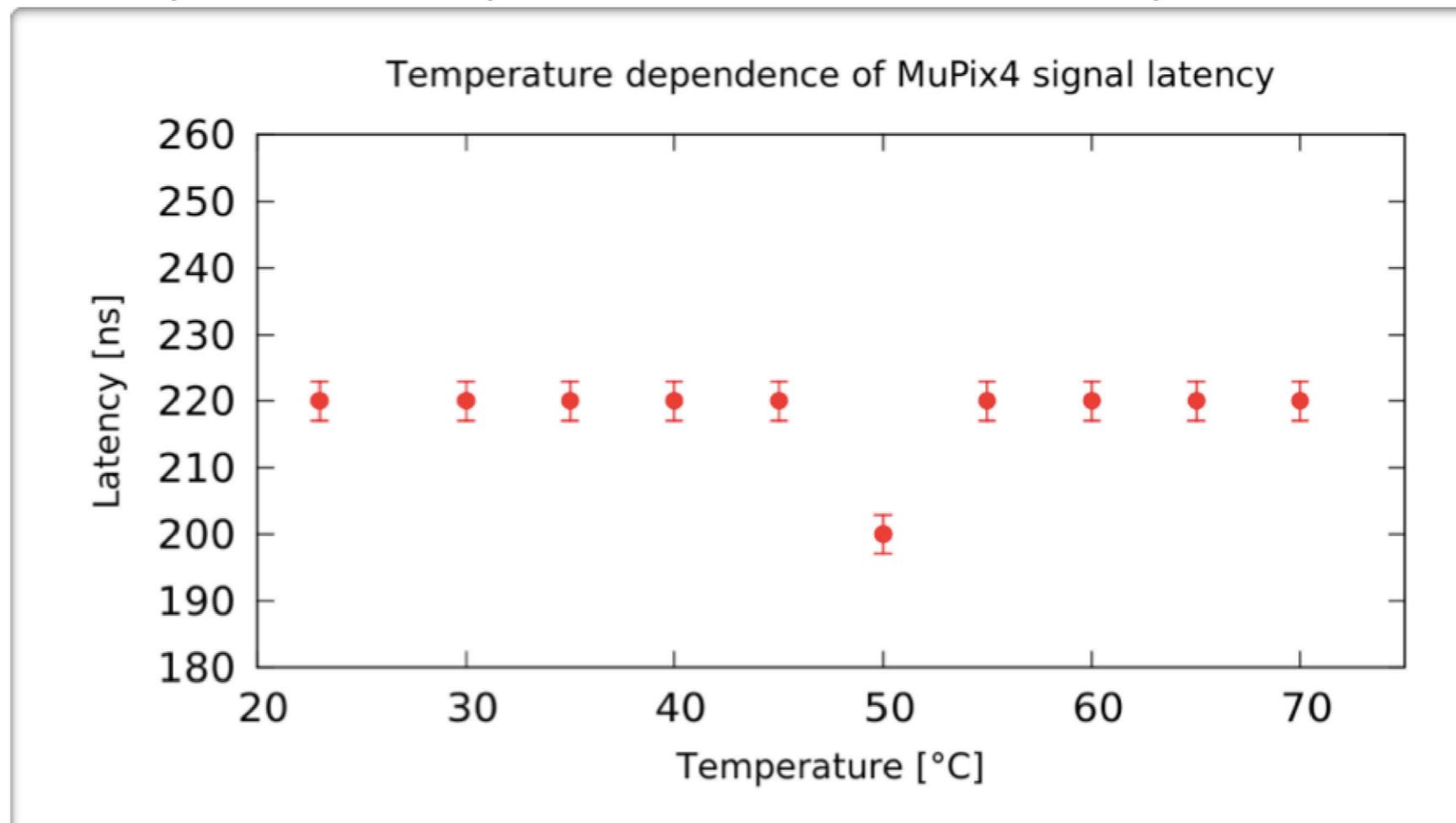
PSI test beam

Result: No significant difference in pulse shape



# Temperature stability

- Latency measurement
- LED pulse to a pixel discriminator output



Result: Temperature dependence within the resolution setup

